

# Design and Tolerance Analysis of a 5.7 GHz Chip-Size Microstrip Antenna on High Resistivity Silicon

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This paper reports the FEM model, design, fabrication and characterization of a square patch antenna built on high-resistivity silicon (HRS) for operation at 5.7 GHz [Figure 1]. The HRS high dielectric constant of 11.7 leads to antenna size reduction enabling the antenna direct coupling on a chip with RF electronics, which offers potential of low cost, low profile and simplified assembly. The metal patch was made using a 2- $\mu\text{m}$  layer of aluminium and has an area of 7.7x7.6 mm<sup>2</sup>. The operating frequency and bandwidth were obtained from reflection measurements and are shown in Figure 2. The efficiency of 18.6% was measured using the Wheeler cap method [Figure 2]. The antenna operates at a center frequency of 5.705 GHz, providing a -10 dB return loss bandwidth of 90 MHz. Far-field gain patterns measurements were done using an anechoic chamber and results compared simulations [Figure 3]. The measured gain is ~0.3 dB. Also, FEM analysis was used to study the tolerance of the substrate thickness, substrate resistivity, oxide thickness and metal conductivity in order to predict the antenna behavior [Figure 4]. It was observed that varying the substrate thickness from 500  $\mu\text{m}$  to 550  $\mu\text{m}$  and oxide thickness from 1  $\mu\text{m}$  to 10  $\mu\text{m}$  the operating frequency changes from around 5.7 GHz to 5.85 GHz. Changing the substrate conductivity from 0.02 S/m to 0.05 S/m we found that efficiency changes from 19.6 % to 30.1 %. A wireless link between two prototypes was established and a power of -50 dBm was received when they were placed one meter apart and the transmitting antenna was fed with 0 dBm.

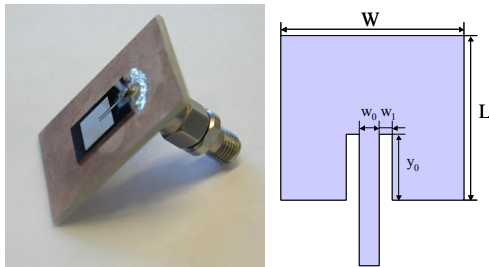


Figure 1 - Patch antenna prototype ( $L = 7.7$ ,  $W = 7.6$ ,  $y_0 = 3.1$ ,  $w_0 = 0.36$ ,  $w_1 = 0.32$ , in mm).

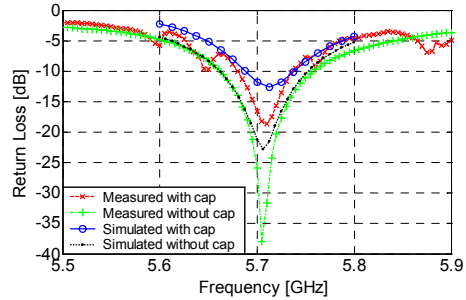


Figure 2 - Co-polar and cross-polar far-field gain patterns obtained at 5.705 GHz.

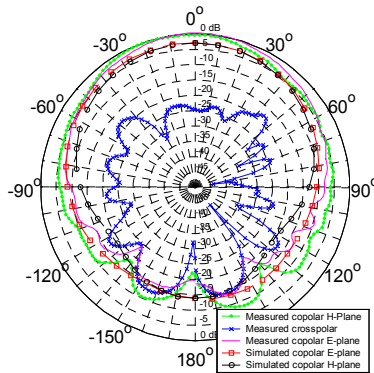


Figure 3 - Return loss used to obtain the antenna operating frequency, bandwidth and efficiency.

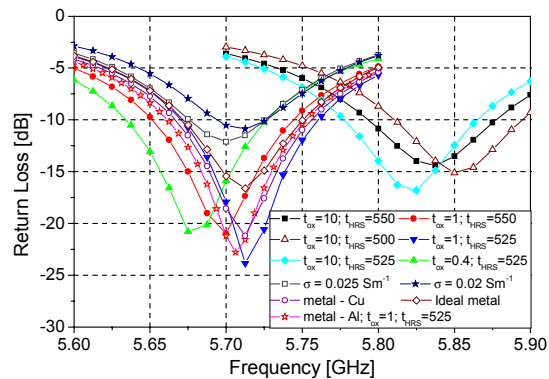


Figure 4 - Influence of wafer parameters ( $t_{ox}$ ,  $t_{HRS}$  - oxide and wafer thickness;  $\sigma$  - wafer conductivity).